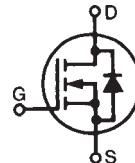


Polar™ Power MOSFET

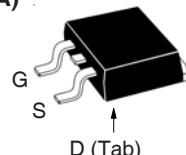
IXTA08N120P
IXTP08N120P

V_{DSS} = **1200V**
I_{D25} = **0.8A**
R_{DS(on)} ≤ **25Ω**

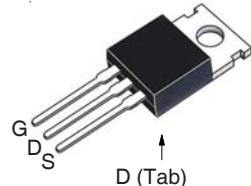
N-Channel Enhancement Mode
Avalanche Rated



TO-263 (IXTA)



TO-220 (IXTP)



G = Gate D = Drain
S = Source Tab = Drain

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T _J = 25°C to 150°C	1200		V
V_{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	1200		V
V_{GSS}	Continuous	±30		V
V_{GSM}	Transient	±40		V
I_{D25}	T _C = 25°C	0.8		A
I_{DM}	T _C = 25°C, pulse width limited by T _{JM}	1.8		A
I_A	T _C = 25°C	0.8		A
E_{AS}	T _C = 25°C	80		mJ
dV/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C	10		V/ns
P_D	T _C = 25°C	50		W
T_J		-55 ... +150		°C
T_{JM}		150		°C
T_{stg}		-55 ... +150		°C
T_L	Maximum Lead Temperature for Soldering	300		°C
T_{SOLD}	1.6 mm (0.062in.) from Case for 10s	260		°C
F_c	Mounting Force (TO-263)	10.65 / 2.2 ... 14.6		N/lb
M_d	Mounting Torque (TO-220)	1.13 / 10		Nm/lb.in
Weight	TO-263	2.5		g
	TO-220	3.0		g

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	V _{GS} = 0V, I _D = 250μA	1200		V
V_{GS(th)}	V _{DS} = V _{GS} , I _D = 100μA	2.5		4.5 V
I_{GSS}	V _{GS} = ±30V, V _{DS} = 0V			±50 nA
I_{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V T _J = 125°C			5 μA 100 μA
R_{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1	20.5	25.0	Ω

Features

- International Standard Packages
- Low Q_G
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Rectifier

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

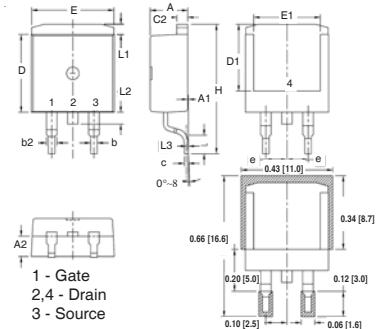
- DC-DC Converters
- Switch-Mode and Resonant-Mode Power Supplies
- AC and DC Motor Drives
- Discharge Circuits in Lasers, Spark Igniters, RF Generators
- High Voltage Pulse Power Applications

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
g_{fs}	$V_{DS} = 30\text{V}$, $I_D = 0.5 \cdot I_{D25}$, Note 1	0.38	0.63	S
C_{iss}	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$	333		pF
		20		pF
		4.7		pF
$Q_{g(on)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$	14.0		nC
		2.0		nC
		8.2		nC
$t_{d(on)}$	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$ $R_G = 50\Omega$ (External)	20		ns
		26		ns
		55		ns
		24		ns
R_{thJC}			2.5 $^\circ\text{C}/\text{W}$	
R_{thCS}	TO-220	0.50		$^\circ\text{C}/\text{W}$

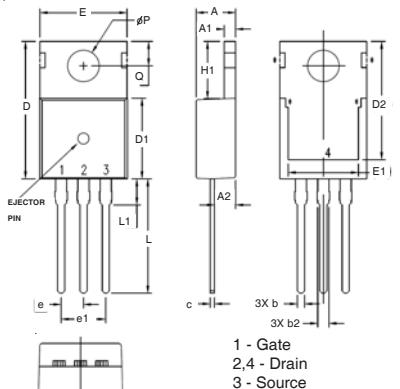
Source-Drain Diode

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
I_s	$V_{GS} = 0\text{V}$		0.8	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}		2.4	A
V_{SD}	$I_F = I_S$, $V_{GS} = 0\text{V}$, Note 1		1.5	V
t_{rr}	$I_F = 0.8\text{A}$, $-di/dt = 100\text{A}/\mu\text{s}$, $V_R = 100\text{V}$	900		ns

Note: 1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

TO-263 Outline


SYM	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	.170	.185	4.30	4.70
A1	.000	.008	0.00	0.20
A2	.091	.098	2.30	2.50
b	.028	.035	0.70	0.90
b2	.046	.060	1.18	1.52
C	.018	.024	0.45	0.60
C2	.049	.060	1.25	1.52
D	.340	.370	8.63	9.40
D1	.300	.327	7.62	8.30
E	.380	.410	9.65	10.41
E1	.270	.330	6.86	8.38
E2	.100	BSC	2.54	BSC
H	.580	.620	14.73	15.75
L	.075	.105	1.91	2.67
L1	.039	.060	1.00	1.52
L2	—	.070	—	1.77
L3	.010	BSC	0.254	BSC

TO-220 Outline


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
b	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
c	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
E	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
e	.100	BSC	2.54	BSC
e1	.200	BSC	5.08	BSC
H1	.244	.268	6.20	6.80
L	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØP	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

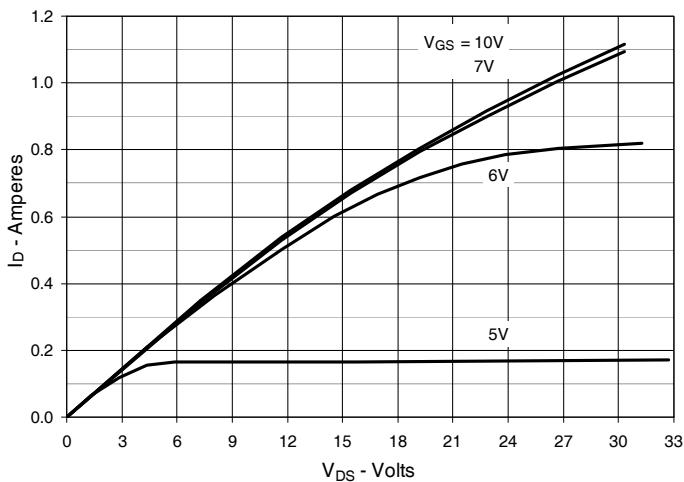
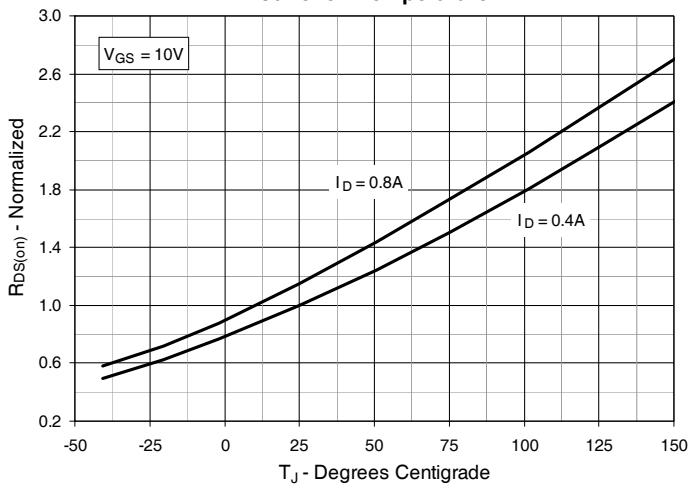
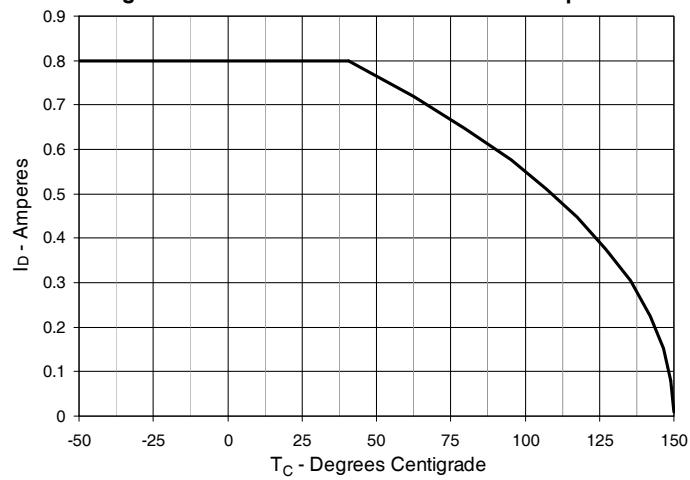
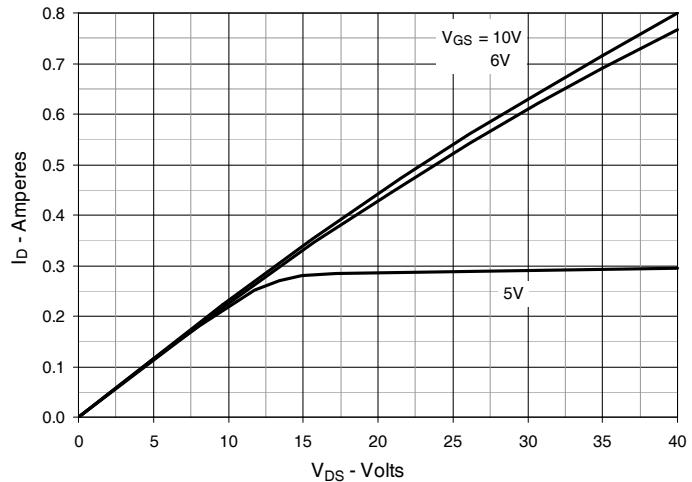
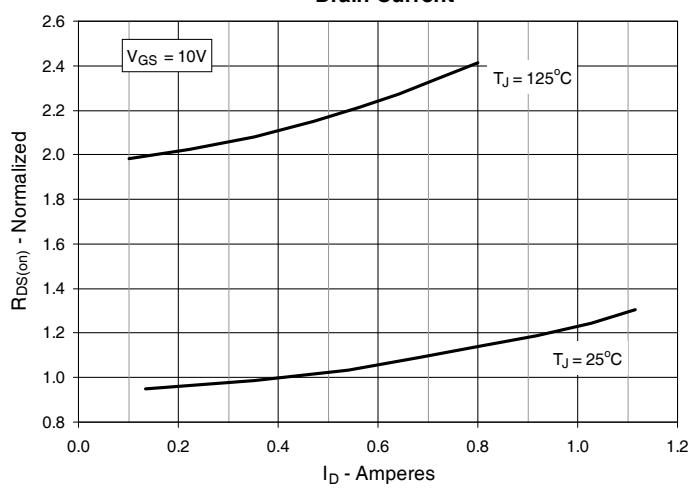
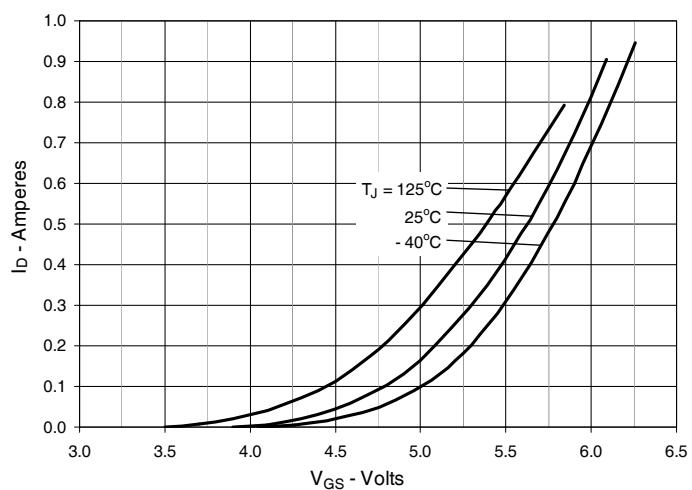
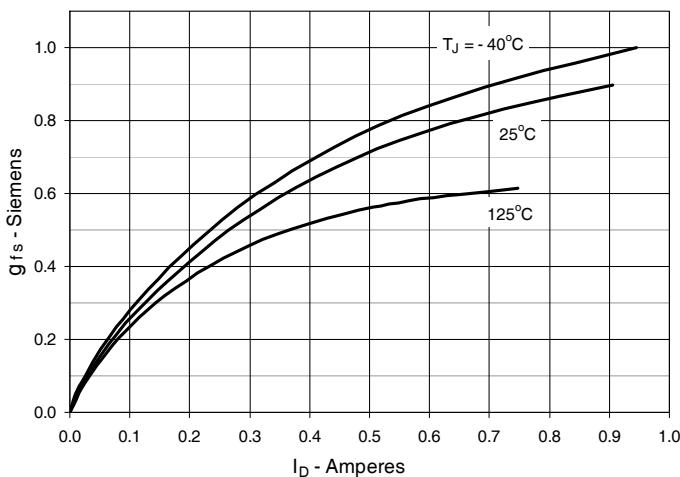
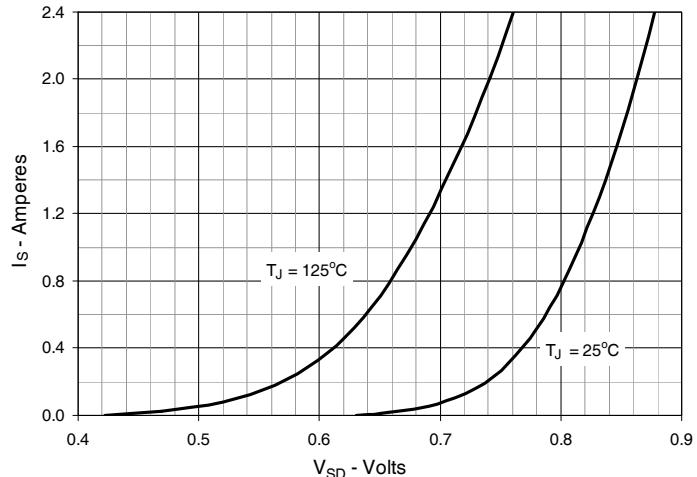
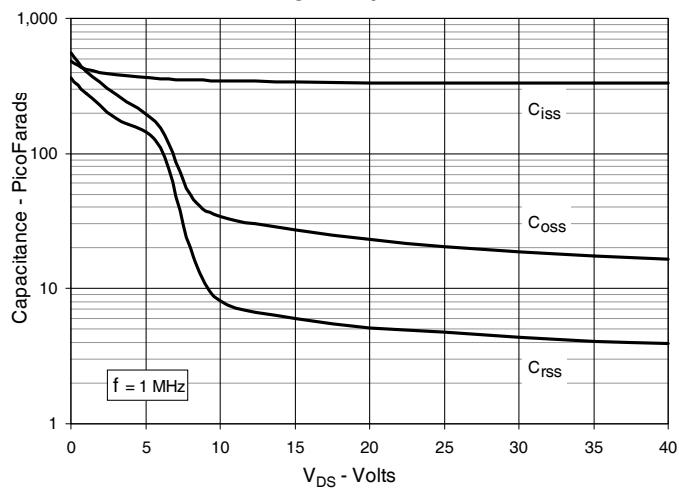
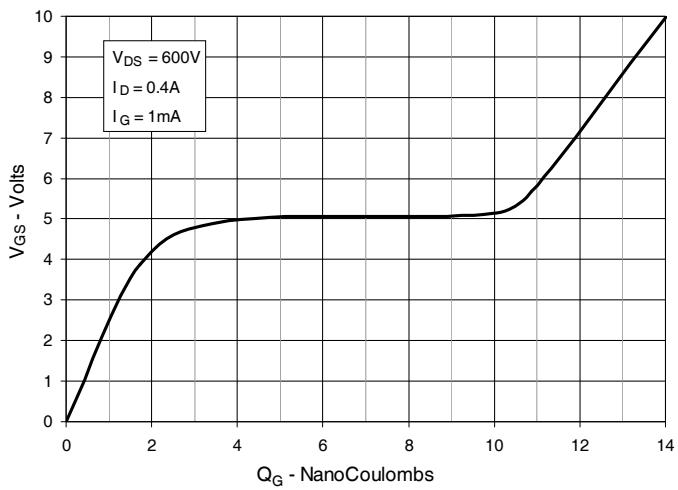
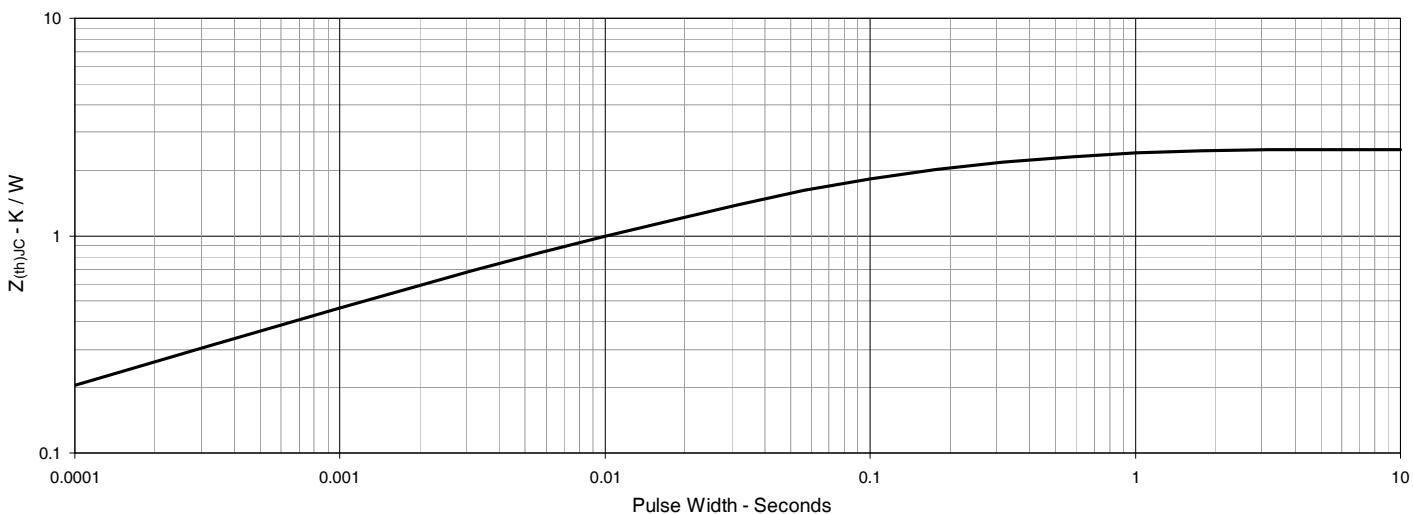
Fig. 1. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. $R_{DS(on)}$ Normalized to $I_D = 0.4A$ Value vs. Junction Temperature

Fig. 5. Maximum Drain Current vs. Case Temperature

Fig. 2. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 0.4A$ Value vs. Drain Current

Fig. 6. Input Admittance


Fig. 7. Transconductance

Fig. 8. Forward Voltage Drop of Intrinsic Diode

Fig. 9. Capacitance

Fig. 10. Gate Charge

Fig. 11. Maximum Transient Thermal Impedance


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